

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Prindiville et al.

Art Unit: 2827

Application No.: 09/971,872

Filed: October 4, 2001

For: SEMICONDUCTOR PACKAGES AND  
METHODS FOR MAKING THE SAME


Examiner: Ishwarbhai B. Patel

Date: November 12, 2002



**CERTIFICATE OF MAILING**

I hereby certify that this paper and the documents referred to as being attached or enclosed herewith are being deposited with the United States Postal Service on November 12, 2002 as First Class Mail in an envelope addressed to: BOX NON-FEE AMENDMENT, COMMISSIONER FOR PATENTS, WASHINGTON, D.C. 20231.

  
Wayne W. Rupert  
Attorney for Applicant

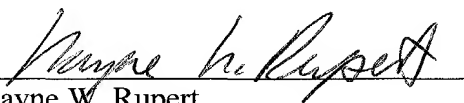
BOX NON-FEE AMENDMENT  
COMMISSIONER FOR PATENTS  
WASHINGTON, DC 20231

**LETTER TO THE OFFICIAL DRAETSPERSON**

Attached are two (2) sheets of corrected drawings (Sheet 1 of 5 and Sheet 4 of 5) for the above-identified patent application, with each sheet indicating the title, inventor's name, and application number on the front of each sheet and centered within the top margin. The corrected drawings now show the cross hatching patterns based on a particular material for each part.

Respectfully submitted,

KLARQUIST SPARKMAN, LLP

By   
Wayne W. Rupert  
Registration No. 34,420

One World Trade Center, Suite 1600  
121 S.W. Salmon Street  
Portland, Oregon 97204  
Telephone: (503) 226-7391  
Facsimile: (503) 228-9446